# **ONSEMÍ**...

# **MOSFET** – N-Channel, SUPERFET<sup>®</sup>

# 600 V, 16 A, 260 m $\Omega$

# FCP16N60, FCPF16N60

#### Description

SUPERFET MOSFET is **onsemi**'s first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.

#### Features

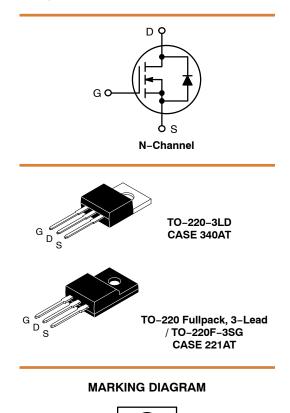
- 650 V @ T<sub>J</sub> = 150°C
- $R_{DS(on)} = 220 \text{ m}\Omega \text{ (Typ.)}$
- Ultra Low Gate Charge (Typ.  $Q_g = 55 \text{ nC}$ )
- Low Effective Output Capacitance (Typ. Coss(eff.) = 110 pF)
- 100% Avalanche Tested
- These are Pb–Free Devices

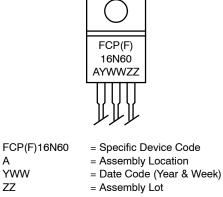
#### Applications

- Solar Inverter
- AC-DC Power Supply

V <sub>DS</sub> R <sub>DS(on)</sub> MAX		I <sub>D</sub> MAX	
600 V	260 mΩ @ 10 V	16 A*	

\*Drain current limited by maximum junction temperature.





#### **ORDERING INFORMATION**

Device	Package	Shipping
FCP16N60	TO-220-3	1000 Units / Tube
FCPF16N60	TO-220-3 FullPak	1000 Units / Tube

Symbol	Parameter		FCP16N60	FCPF16N60	Unit
V <sub>DSS</sub>	Drain-Source Voltage		600		V
I <sub>D</sub>	Drain Current	– Continuous (T <sub>C</sub> = 25°C)	16	16*	Α
		– Continuous (T <sub>C</sub> = 100°C)	10.1	10.1*	
I <sub>DM</sub>	Drain Current	– Pulsed (Note 1)	48	48*	А
V <sub>GSS</sub>	Gate-Source Voltage ±30		:30	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		450		mJ
I <sub>AR</sub>	Avalanche Current (Note 1)			16	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		2	20.8	
dv/dt	Peak Diode Recovery	dv/dt (Note 3)	4	4.5	
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25°C)	167	37.9	W
		– Derate Above 25°C	1.33	0.3	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage	Temperature Range	–55 t	-55 to +150	
ΤL	Maximum Lead Tempe 1/8" from Case for 5 Se		300		°C

#### MOSFET MAXIMUM RATINGS (T<sub>C</sub> = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality Stresses exceeding those listed in the Maximum Ratings table may damage to should not be assumed, damage may occur and reliability may be affected. \*Drain current limited by maximum junction temperature. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 8 \text{ A}$ ,  $V_{DD} = 50 \text{ V}$ ,  $R_G = 25 \Omega$ , starting  $T_J = 25^{\circ}\text{C}$ . 3.  $I_{SD} \le 16 \text{ A}$ , di/dt  $\le 200 \text{ A/}\mu\text{s}$ ,  $V_{DD} \le \text{BV}_{DSS}$ , starting  $T_J = 25^{\circ}\text{C}$ .

#### THERMAL CHARACTERISTICS

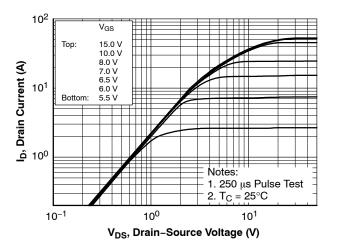
Symbol	Parameter	FCP16N60	FCPF16N60	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.75	3.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	

## **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS					
BV <sub>DSS</sub>	3V <sub>DSS</sub> Drain to Source Breakdown Voltage	$I_D$ = 250 $\mu A,V_{GS}$ = 0 V, $T_J$ = 25°C	600	-	-	V
		$I_D$ = 250 µA, $V_{GS}$ = 0 V, $T_J$ = 150°C	-	650	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_{,l}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$	-	0.6	-	V/°C
BV <sub>DS</sub>	Drain-Source Avalanche Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 16 A	_	700	_	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_	-	1	μA
		V <sub>DS</sub> = 480 V, T <sub>C</sub> = 125°C	_	-	10	
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	_	-	±100	nA
ON CHARA	CTERISTICS			1	<b></b>	1
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \ \mu A$	3.0	_	5.0	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8 A	-	0.22	0.26	Ω
<b>9</b> FS	Forward Transconductance	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 8 A	-	11.5	-	S
DYNAMIC (	CHARACTERISTICS	•				
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	1730	2250	pF
C <sub>oss</sub>	Output Capacitance		-	960	1150	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	85	-	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS}$ = 480 V, $V_{GS}$ = 0 V, f = 1 MHz	-	45	60	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$	-	110	-	pF
Qg	Total Gate Charge at 10 V	$V_{DS} = 480 \text{ V}, I_D = 16 \text{ A}, V_{GS} = 10 \text{ V}$	-	55	70	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	(Note 4)	-	10.5	13	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		-	28	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	1.7	-	Ω
SWITCHING	G CHARACTERISTICS					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 16 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$	-	42	85	ns
t <sub>r</sub>	Turn–On Rise Time	R <sub>G</sub> = 25 Ω (Note 4)	-	130	270	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	]	-	165	340	ns
t <sub>f</sub>	Turn-Off Fall Time	]	-	90	190	ns
DRAIN-SO	URCE DIODE CHARACTERISTICS AND	MAXIMUM RATINGS				
IS	Maximum Continuous Drain to Source Diode Forward Current		_	-	16	А
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		_	-	48	А
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 16 A$	_	-	1.4	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS}$ = 0 V, I <sub>SD</sub> = 16 A, dI <sub>F</sub> /dt = 100 A/µs	-	435	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	1	-	7.0	_	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

#### **TYPICAL PERFORMANCE CHARACTERISTICS**





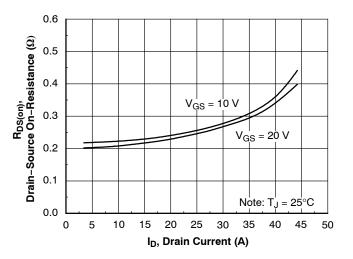


Figure 3. On-Resistance Variation vs. Drain Current and Gate voltage

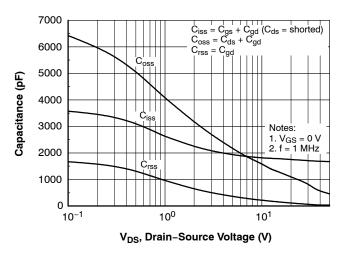
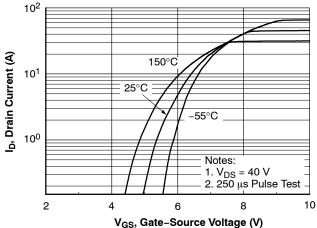


Figure 5. Capacitance Characteristics





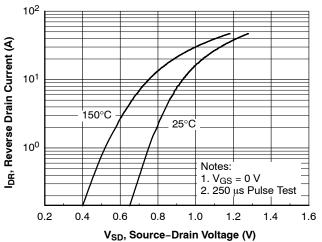


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

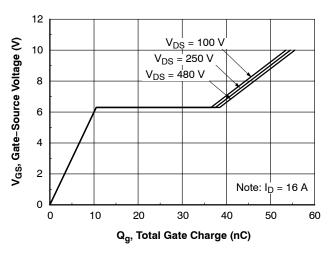
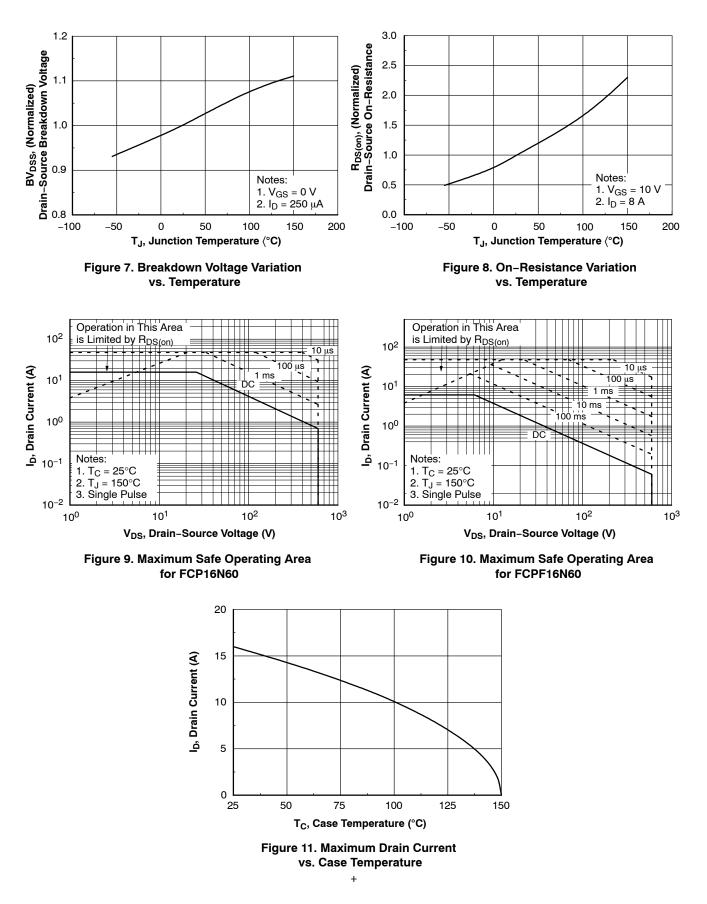


Figure 6. Gate Charge Characteristics

#### TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



## TYPICAL PERFORMANCE CHARACTERISTICS (continued)

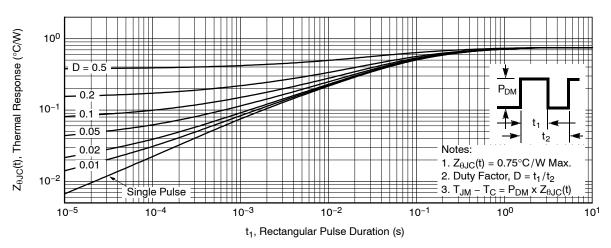


Figure 12. Transient Thermal Response Curve for FCP16N60

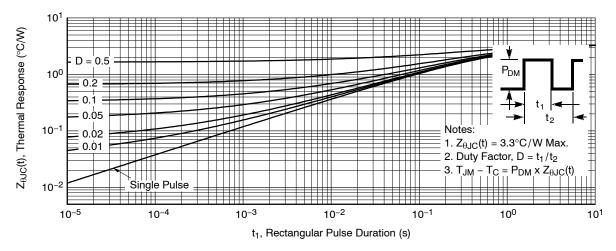
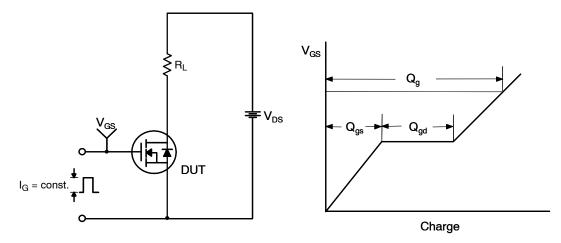


Figure 13. Transient Thermal Response Curve for FCPF16N60





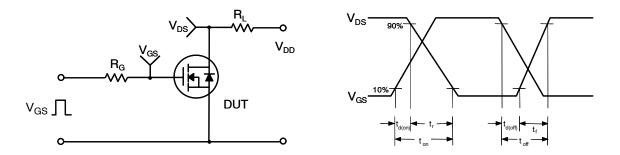


Figure 15. Resistive Switching Test Circuit & Waveforms

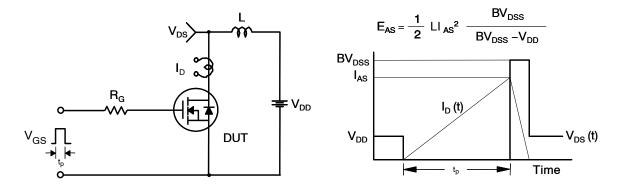


Figure 16. Unclamped Inductive Switching Test Circuit & Waveforms

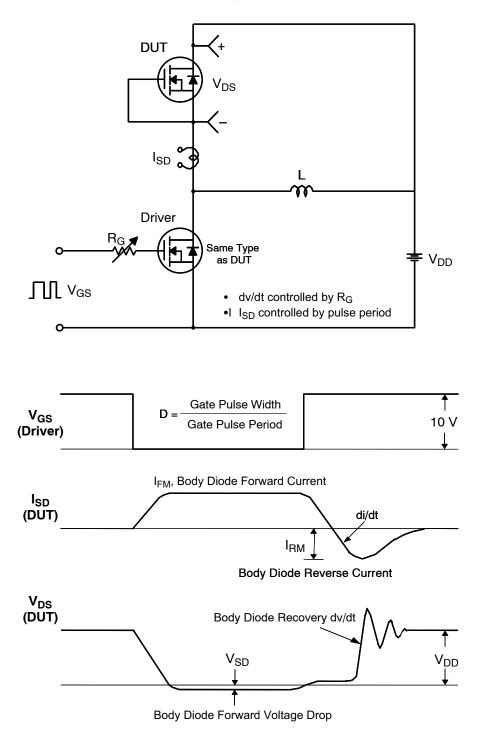
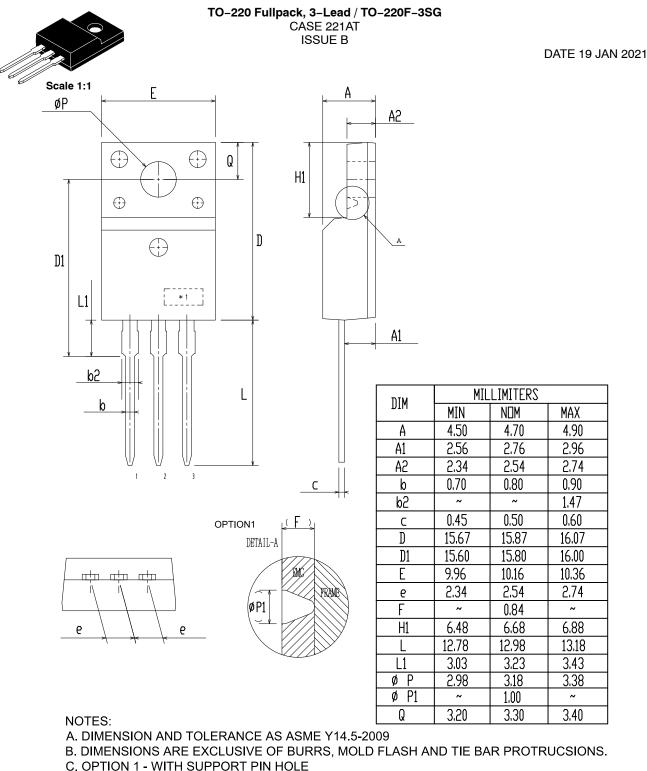


Figure 17. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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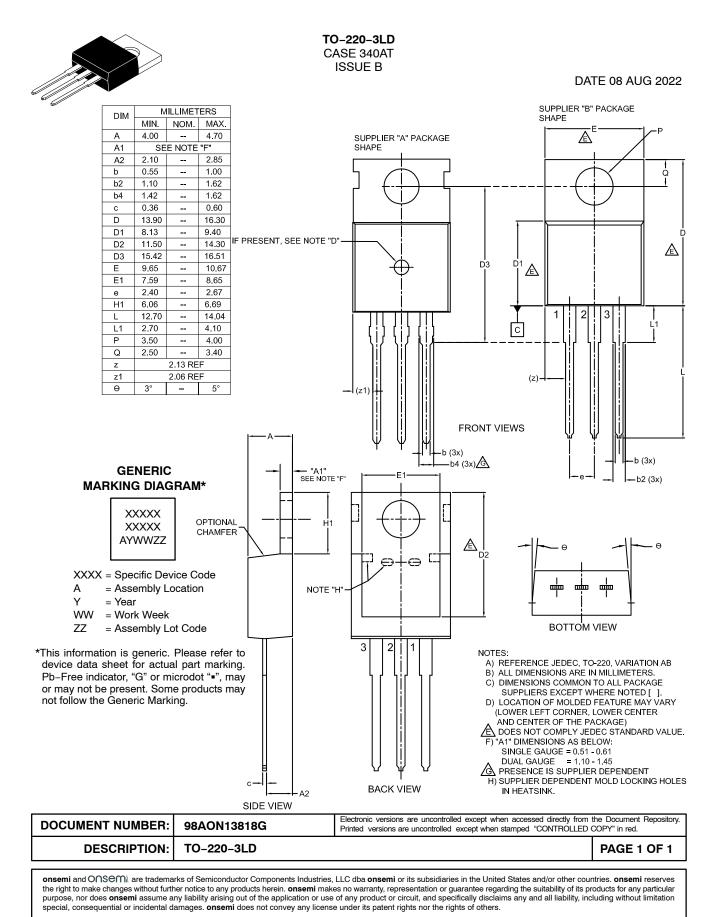


OPTION 2 - NO SUPPORT PIN HOLE

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